



UFZ34

Preliminary

Power MOSFET

28A, 60V N-CHANNEL POWER MOSFET

DESCRIPTION

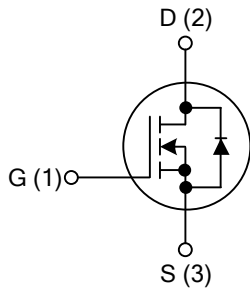
The UTC **UFZ34** is an N-channel Power MOSFET, it uses UTC's advanced technology to provide the customers with a minimum on state resistance, high switching speed and low gate charge.

The UTC **UFZ34** is suitable for all commercial-industrial applications, etc.

FEATURES

- * $R_{DS(ON)} < 0.042\Omega$ @ $V_{GS}=10V, I_D=17A$
- * High switching speed
- * Low gate charge

SYMBOL

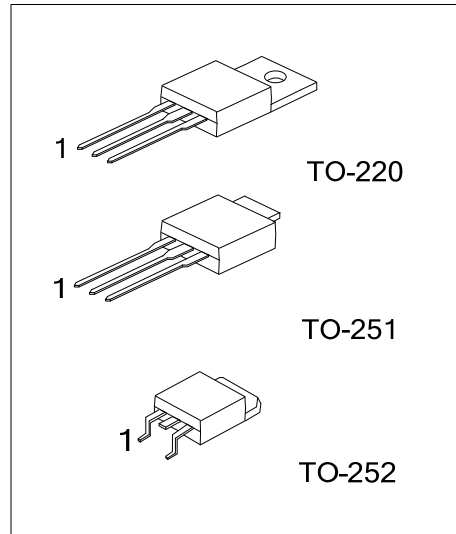


ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
UFZ34L-TA3-T	UFZ34G-TA3-T	TO-220	G	D	S	Tube
UFZ34L-TM3-T	UFZ34G-TM3-T	TO-251	G	D	S	Tube
UFZ34L-TN3-R	UFZ34G-TN3-R	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

<p>UFZ34L-TA3-T</p> <p>(1) Packing Type</p> <p>(2) Package Type</p> <p>(3) Lead Free</p>	<p>(1) T: Tube, R: Tape Reel</p> <p>(2) TA3: TO-220, TM3: TO-251, TN3: TO-252</p> <p>(3) L: Lead Free, G: Halogen Free</p>
------------------------------------------------------------------------------------------	----------------------------------------------------------------------------------------------------------------------------



■ ABSOLUTE MAXIMUM RATINGS

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V_{DSS}	60	V	
Gate-Source Voltage		V_{GSS}	± 20	V	
Drain Current	Continuous	I_D	$T_C=25^\circ\text{C}$	28	A
			$T_C=100^\circ\text{C}$	20	A
	Pulsed (Note 1)		I_{DM}	112	A
Avalanche Current (Note 1)		I_{AR}	17	A	
Avalanche Energy	Single Pulsed (Note 2)	E_{AS}	97	mJ	
	Repetitive (Note 1)	E_{AR}	6.8	mJ	
Peak Diode Recovery dv/dt (Note 3)		dv/dt	5.0	V/ns	
Power Dissipation	$T_C=25^\circ\text{C}$	P_D	68	W	
Linear Derating Factor			0.46	W/ $^\circ\text{C}$	
Junction Temperature		T_J	-55~+175	$^\circ\text{C}$	
Storage Temperature Range		T_{STG}	-55~+175	$^\circ\text{C}$	

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged.
Absolute maximum ratings are stress ratings only and functional device operation is not implied.

■ THERMAL CHARACTERISTICS

PARAMETER	SYMBOL	RATING	UNIT
Junction to Ambient	θ_{JA}	62	$^\circ\text{C}/\text{W}$
Junction to Case	θ_{JC}	3.3	$^\circ\text{C}/\text{W}$

Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. $L=670\mu\text{H}$, $I_{AS}=17\text{A}$, $R_G=25\Omega$, Starting $T_J=25^\circ\text{C}$.
3. $I_{SD}\leq 17\text{A}$, $di/dt\leq 200\text{A}/\mu\text{s}$, $V_{DD}\leq BV_{DSS}$, Starting $T_J\leq 175^\circ\text{C}$.

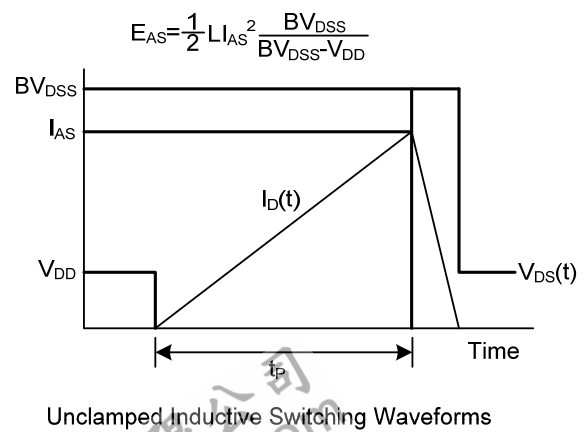
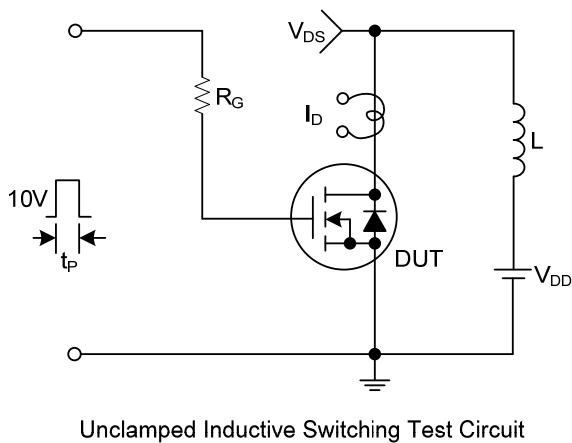
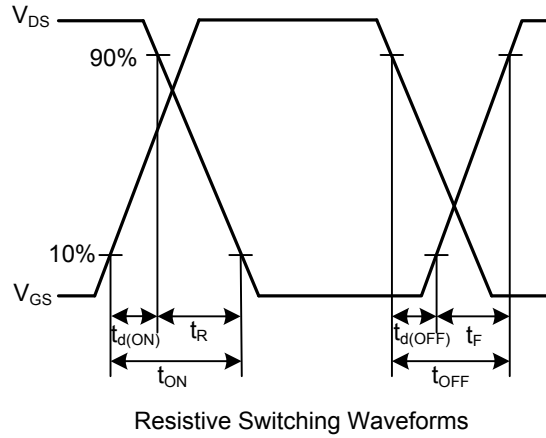
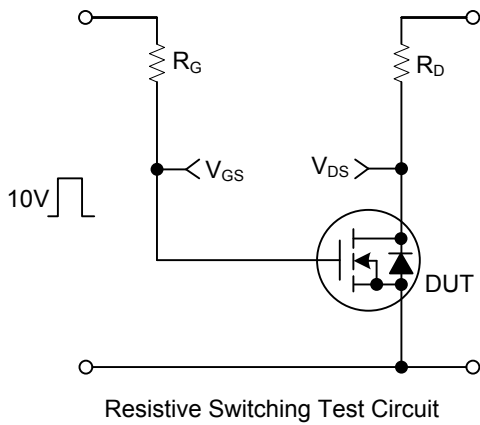
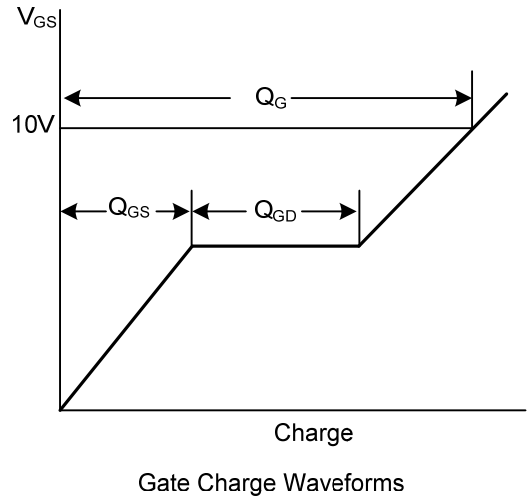
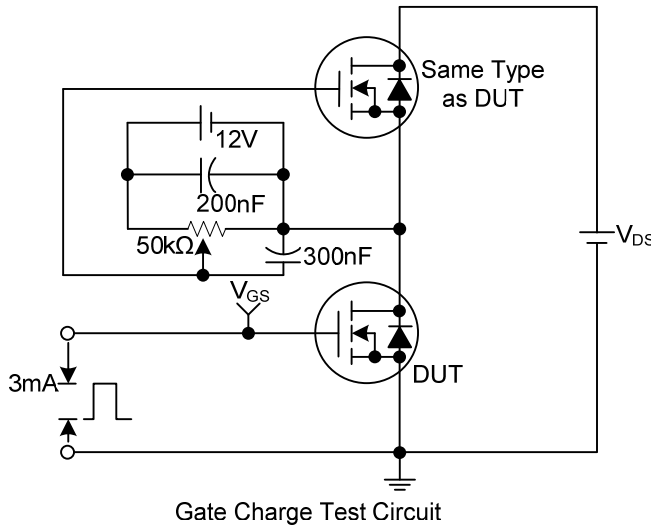
■ ELECTRICAL CHARACTERISTICS ($T_J=25^\circ\text{C}$, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	$I_D=250\mu\text{A}$, $V_{GS}=0\text{V}$	60			V
Drain-Source Leakage Current	I_{DSS}	$V_{DS}=60\text{V}$, $V_{GS}=0\text{V}$			25	μA
Gate-Source Leakage Current	Forward Reverse	I_{GSS}			+100	nA
					-100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_D=250\mu\text{A}$	2.0		4.0	V
Static Drain-Source On-State Resistance (Note 2)	$R_{DS(ON)}$	$V_{GS}=10\text{V}$, $I_D=17\text{A}$			0.042	Ω
DYNAMIC PARAMETERS						
Input Capacitance	C_{ISS}	$V_{GS}=0\text{V}$, $V_{DS}=25\text{V}$, $f=1.0\text{MHz}$		680		pF
Output Capacitance	C_{OSS}			220		pF
Reverse Transfer Capacitance	C_{RSS}			80		pF
SWITCHING PARAMETERS						
Total Gate Charge	Q_G	$V_{GS}=10\text{V}$, $V_{DS}=48\text{V}$, $I_D=17\text{A}$ (Note 4)			30	nC
Gate to Source Charge	Q_{GS}				6.7	nC
Gate to Drain Charge	Q_{GD}				12	nC
Turn-ON Delay Time	$t_{D(ON)}$	$V_{DD}=30\text{V}$, $I_D=17\text{A}$, $R_G=13\Omega$, $R_D=1.8\Omega$ (Note 2)		5.1		ns
Rise Time	t_R			30		ns
Turn-OFF Delay Time	$t_{D(OFF)}$			22		ns
Fall-Time	t_F			30		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS						
Maximum Body-Diode Continuous Current	I_S				28	A
Maximum Body-Diode Pulsed Current (Note 1)	I_{SM}				100	A
Drain-Source Diode Forward Voltage (Note 2)	V_{SD}	$T_J=25^\circ\text{C}$, $I_S=17\text{A}$, $V_{GS}=0\text{V}$			1.3	V
Body Diode Reverse Recovery Time	t_{RR}	$T_J=25^\circ\text{C}$, $I_F=17\text{A}$, $di/dt=100\text{A}/\mu\text{s}$		63	95	ns
Body Diode Reverse Recovery Charge (Note 2)	Q_{RR}			130	200	nC
Forward Turn-On Time	t_{ON}	Intrinsic turn-on time is negligible (turn-on is dominated by L_S+L_D)				

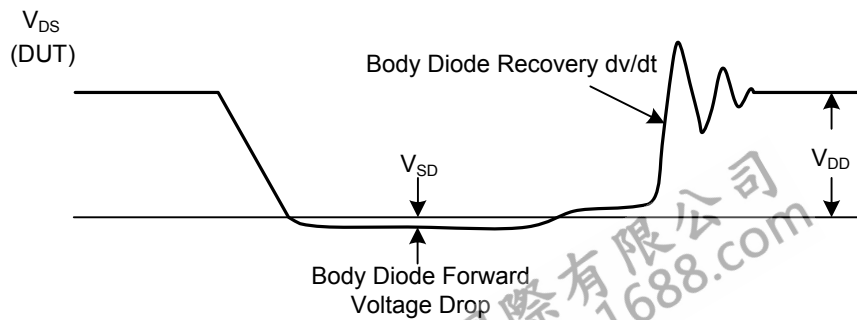
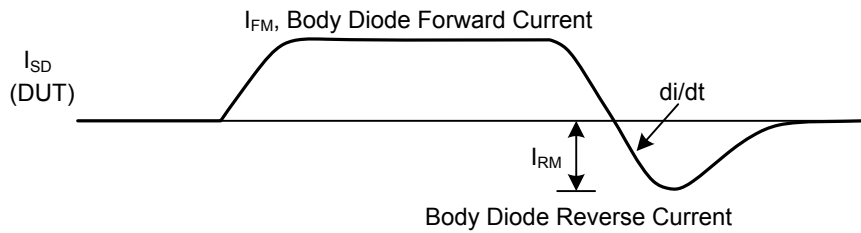
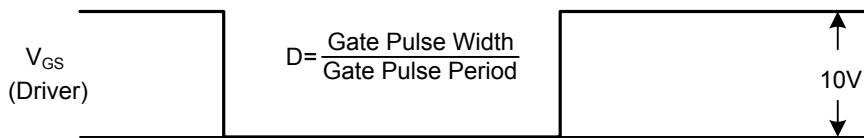
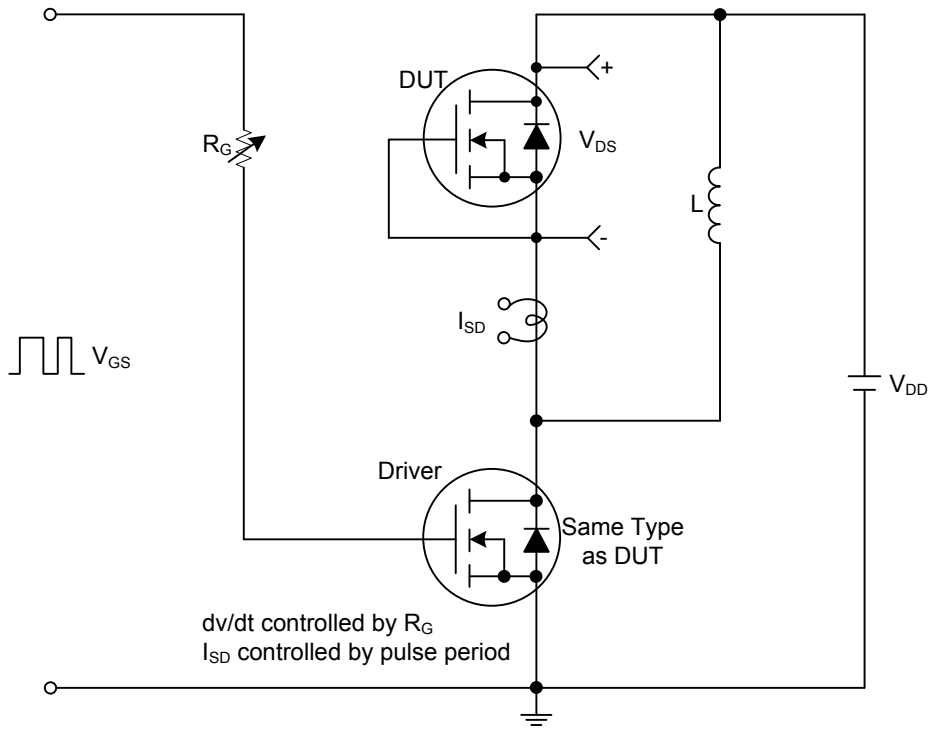
Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$.

■ TEST CIRCUITS AND WAVEFORMS



■ TEST CIRCUITS AND WAVEFORMS



Peak Diode Recovery dv/dt Test Circuit and Waveforms

UTC assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all UTC products described or contained herein. UTC products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner. The information presented in this document does not form part of any quotation or contract, is believed to be accurate and reliable and may be changed without notice.